Notification Number:	20161213000		<b>Notification Date:</b>			December 13, 2016	
Title: Datasheet for TLC3702-Q1							
Customer Contact:         PCN Manager         Dept:         Quality Services							
Change Type:							
Assembly Site		Design			Wafer	· Bump Site	
Assembly Process	$\triangleright$	🛛 Data Sheet			Wafer Bump Material		
Assembly Materials		Part number change			Wafer Bump Process		
Mechanical Specification		Test Site			Wafer Fab Site		
Packing/Shipping/Labeling		Test Process				· Fab Materials	
					Wafer	· Fab Process	
Notification Details							
Description of Change:							
Texas Instruments Incorporated is announcing an information only notification.							
The product datasheet(s) is updated as seen in the change revision history below:							
						TEXAS INSTRUMENTS	
TLC3702-Q1						INSTRUMENTS	
SGLS156F-MARCH 2003-REVISED DECEMBER	R 2016					www.ti.com	
Changes from Revision E (August 2012) to Revision F					Page		
	-						
<ul> <li>Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Device Supply Description and Level applies, and Desumated in Support Section, and</li> </ul>							
	section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section						
Deleted Ordering Information table; see POA at the end of the datasheet							
Changed the Description section							
Changed Equation 2 in Detailed Design Procedure from "R2 + R1//R" to "R1 + R2//R"							
Changed "Output is high" to "Output is low"							
Deleted Enhanced Supply Supervisor schematics and Pulse-Width-Modulated Motor Speed Controller schematic							
Added missing resistors to Two-Phase Non-Overlapping Clock Generator schematic and changed in NOTES A:							
from "1.85" to "2 × 1.71"         18           • Deleted the Micropower Switching Regulator image.         19							
• Deleted the micropower Switching Regulator image							
The datasheet number will be	changin	ng.					
Device Family			Cha	inge	From:	Change To:	
TLC3702-Q1			SGL	_S15	6E	SGLS156F	
These changes may be reviewed at the datasheet links provided.							
http://www.ti.com/lit/ds/sym							
Reason for Change:							
To more accurately reflect de	vice char	racteristics.					
Anticipated impact on Fit,	Form, F	unction, Qual	ity or Reliat	bility	y (posi	tive / negative):	
No anticipated impact. This is to the actual device	a specif	ication change	announceme	nt o	nly. The	ere are no changes	
Changes to product identif	ication	resulting fron	this notifie	cati	on:		
None.							
Product Affected:							
TLC3702QDRG4Q1		3702QDRQ1	1	TIC	37020	PWRQ1	
		-,				· ····\~	
For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.							

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com